USB Type C DFP+ USB-A Power Bank with Input & Output Fast Charger Reference Design

Project Title:
Designed for:
Public Release
Assembly Variant:
001

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Drawn By:
Engineer:
Yingyang Ou

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Revision History

Revision | Notes
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1.0 | For Release
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Version control disabled

SVN Rev: PMP4451

Number:

Rev:

TID #:
PMP4451

Orderable:

N/A

Legend

PCB
LOGO
Pb-Free Symbol

Label Table

Variant | Label Text
--------|-----------------
001    | ChangeMe!
002    | ChangeMe!

Assembly Notes:

ZZ1 | Assembly Notes
These assemblies are ESD sensitive. ESD precautions shall be observed.

ZZ2 | Assembly Notes
These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.

ZZ3 | Assembly Notes
These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.
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